

## **INFRARED COMPONENT**

PRODUCT BROCHURE

One-stop Optoelectronic System Solution Provider



## VITAL OPTICS TECHNOLOGY CO., LTD.

- # www.votinfrared.com
- No.100, Nanjing Road, Langya EconomicDevelopment Zone, Chuzhou City, AnhuiProvince, China

## **Table Of Contents**

To Empower Humans To

Perceive The World In More Dimensions



### **Company Introduction** Mission Vision Values 01 Company Introduction 02 Qualifications And Awards 03 Core Technology 04 Global Layout 05 **Product Introduction Cooled Series** Cryocooler 08 Cooled Infrared Detector 11 Cooled Infrared Camera Core 19 **Uncooled Series** Uncooled Infrared Detector 25 Uncooled Infrared Camera Core 29



## **Our Mission**

To empower humans to perceive the world in more dimensions



## **Our Vision**

To make the world more intelligent



## **Our Values**

Respect, Collaboration, Perseverance, Innovation

# **COMPANY**INTRODUCTION

VOT (Vital Optics Technology Co., LTD) was listed on the Growth Enterprise Market of the Shenzhen Stock Exchange in July 2015, with the stock code: 300489.

VOT is a dedicated national high-tech enterprise specializing in optoelectronic technology, positioning us at the vanguard of innovation in this field. With comprehensive capabilities spanning the entire industry chain, we are capable of full-scale production from the growth of optoelectronic materials, chip design, key sensor manufacturing, to system integration. We offer a diverse range of products and solutions tailored to the needs of the global market: Infrared materials and components, MEMS and detectors, Customized core and lens assemblies, Multifunctional thermal imaging cameras, Tailored integrated optoelectronic systems and solutions. Our product applications span a diverse array of cutting-edge fields: Artificial Intelligence, Semiconductor technology, Advanced materials science, Renewable energy solutions, Medical diagnostics, Sophisticated scientific instruments, Large-scale research equipment, Night vision for outdoor applications, Industrial thermal measurement, Machine vision technology, Internet of Things devices, Environmental monitoring systems, Unmanned Aerial Vehicle payloads, Autonomous driving technologies.

VOT's commitment to innovation and quality ensures that our products meet the rigorous demands of these industries, positioning us as a trusted partner for customers seeking advanced optoelectronic solutions.



## QUALIFICATIONS AND AWARDS

Led by a team of doctoral experts

## Applied for 1164 patents

631 patents

**498** patents

**Utility model patents** 

35 patents

Design patents

Invention patents













- ISO 9001:2015 Quality Management System Certificate
- ISO 14001:2015 Environmental Management System Certificate
- ISO 45001:2018 Occupational Health and Safety Management System Certificate

## **CORE TECHNOLOGY**

## **Downstream**

Cameras and Systems



#### • Artificial Intelligence

We can provide customers with personalized integrated optoelectronic systems and solutions. We have developed a series of products for different industry applications such as outdoor, security, industrial temperature measurement, intelligent driving, gas detection. With independent intellectual property rights, these products can be applied in scenarios such as outdoor observation, forest fire prevention, gas leakage detection, fire warning, security monitoring, power detection, and warehouse management.

#### Uncooled Detector

We have built an 8-inch silicon-based MEMS infrared detector production line, with an annual capacity of 100,000 sets. We have broken through the core technology of infrared thermal imaging. The uncooled detectors have achieved the million-pixel level, with technology at the leading domestic level.

#### Cooled Detector

We have completed the construction of 2-6 inch various cooled infrared detector chip production lines (including mid-wave MCT, InSb, mid-wave high-temperature, and long-wave type II superlattice detector chips), matched with self-developed and produced cryocoolers and Dewars, forming a complete cooled infrared detector industry chain covering infrared materials, chips, packaging and end products.

## **Upstream**

Photoelectric Materials



## Midstream

**Core Components** 

#### Crystal Growth

As a leading enterprise in the field of crystal materials, we possess a variety of growth technologies, such as the Czochralski method (CZ), Vertical Gradient Freeze (VGF), Bridgeman method, Chemical Vapor Deposition (CVD), etc., capable of growing high-quality crystals.

#### Precision Processing

We provide processing, coating, and product inspection services for various components, offering customers a full range of services including material slicing, rolling, milling, polishing, aspheric and bi-element surface processing, and coating. We have a comprehensive quality assurance system and have passed the ISO9001 quality certification, establishing a robust quality management system.

#### Infrared Materials

We are one of the few global suppliers capable of producing and mass-supplying Zinc Selenide (ZnSe) materials. Our proprietary 13N ultra-high purity germanium has filled the domestic gap and represents a significant breakthrough in the field of electronic materials.

## **GLOBAL LAYOUT**



# APPLICAION FIELDS



## Cryocooler

VOT (Vital Optics Technology Co., Ltd) has built a R&D and manufacturing platform for low-temperature cryocooler and corresponding dewar technology, has mastered the relevant cryocooler capabilities, including simulation, design, and pilot productin, as well as mass production, environmental testing, life testing, and other capabilities. Rotary integral Stirling cryocooler, linear split Stirling cryocooler, and free piston cryocooler are among the products available. These products can provide cooling capacity of 65K-150K. It has been confirmed that the product's reliability and life have reached advanced level in the industry, allowing it to satisfy the needs of cooling and packaging in cooled infrared as well as similar application fields.

## **Rotary Integrated Cryocooler**









RM05 Stirling Cooler

RM04 Stirling Cooler

RM02T Stirling Cooler

RM10 Stirling Cooler

#### ■ Product Advantages







High temperature stability (<0.5K)

#### ■ Product Specifications

Model Number	RM05 Stirling Cooler	RM04 Stirling Cooler	RM02T Stirling Cooler	RM10 Stirling Cooler
Input voltage	18~28VDC	8~16VDC	8~16VDC	18V~28V
Cooling power	≥550mW@77K@23°C	≥400mW@77K@23°C	≥1000mW@150K@23°C	≥800mW@77K@70°C
Cooldown time	≤5min@250J@77K@23°C	≤4min30s@250J@77K@23°C	<pre>&lt;2min@150J@150K@23°C</pre>	≤5min@500J@77K@23°C
Maximum Input Power	18W	18W	12W	36W
Steady Input Power	≤7W@220mW@77K@23°C	≤5W@130mW@77K@23°C	<2.5W@150mW@150K@23°C	≤15W@550mW@77K@23°C
Weight	≤450g	≤290g	≤150g	≤580g
Maximum size (mm)	116x58.5x71	99.5x46.5x66.5	72×42×42	116×57×78
Operating temperature	-55°C~71°C	-55°C~71°C	-55°C~71°C	-55°C~71°C
MTTF	≥10000h	≥8000h	≥10000h	≥10000h
Cold Finger Size	Ф8mm	Ф6.3mm	Ф6.3mm	Ф9.3mm

## **Linear Splitied Cryocooler**

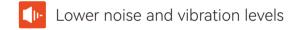


#### ■ Product Advantages









#### ■ Product Specifications

Model Number	LS05E Stirling Cooler	LS05F Stirling Cooler	LS07 Stirling Cooler	LS10 Stirling Cooler
Input voltage	8~16VDC	8~16VDC	24VDC	24VDC
Cooling power	≥1000mW@120K@23°C	≥1000mW@150K@23°C	≥700mW@80K@23°C	≥1000mW@77K@23°C
Cooldown time	≤3min@150J@120K@23°C	≤2min@150J@150K@23°C	≤3min@250J@80K@23°C	≤5min@500J@77K@23°C
Maximum Input Power	20W	15W	30W	45W
Steady Input Power	≤3.5W@150mW@120K@23°0	≤2.5W@150mW@150K@23°C	<8.0W@200mW@80K@23°C	≤10.0W@250mW@77K@23°C
Weight	≤215g	≤210g	≤340g	≤700g
Maximum size (mm)	Compressor: Φ30×58 Expander: 21.8×52	Compressor: Φ28.5×58 Expander: 22×50	Compressor: Φ33.5×74.9 Expander: 31.9×85.4	Compressor: Ф42×115 Expander: 35×87
Operating temperature	-55°C~71°C	-55°C~71°C	-55°C~71°C	-55°C~71°C
MTTF	≥20000h	≥20000h	≥20000h	≥30000h
Cold Finger Size	Ф6.3mm	Ф6.3mm	Ф8mm	Ф9.3mm

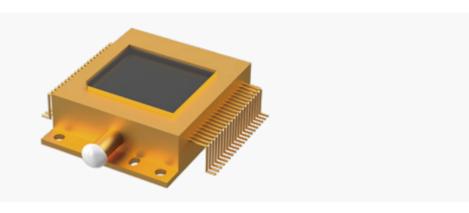
## **Cooled Infrared Detector**

VOT (Vital Optics Technology Co., Ltd) has built production lines for MCT ,InSb and T2SL detectors. The detector's spectral range covers short waves, medium waves and long waves, and supports multiple resolutions including  $320\times256$ ,  $640\times512$  and  $1280\times1024$ . Among these, pixel pitch as small as  $10\mu m$  can achieve higher spatial resolution, match optical lenses with shorter focal lengths, while maintaining the same detecting distance.

VOT (Vital Optics Technology Co., Ltd) can realize the large-scale production of domestic infrared detector components, and master the complete set of technologies of element purification, substrate, epitaxy, chip, circuit, cryocooler, packaging and testing for the cooled infrared detectors. The company also has the industrial production capacity of various types of MWIR cooled detectors, which can achieve larger field of view, longer detecting distance and smaller size of systems.

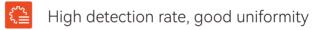
The various types of infrared detector components can be applied to a variety of commercial infrared fields such as seaside detection, gas detection, industrial inspection and forest fire prevention.

#### **InGaAs Short Wave Infrared Detector**



VS0615I

#### ■ Product Advantages



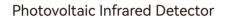
#### Product Specifications

Model Number	VS0615I
Array size	640×512
Pixel size	15μm
Spectral range	0.9~1.7μm
Quantum efficiency	≥70%
Corresponding inhomogeneity	< 6%
Effective pixel rate	≥99.5%
Refrigeration mode	Secondary TEC refrigeration
Dark current	≤10nA/cm² @20°C
Frequency frame	The maximum value is ≥300Hz@8 channels
Operating temperature	-40°C~70°C
Overall dimension	32mm×23.5mm×7.5mm
Encapsulation form	40-pin metal vacuum package
weight	≤20g

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## **Infrared Detector**







Photoconductive Infrared Detector

#### Product Advantages

TO compa

TO compact package



high sensitivity



RoHS-compliant

#### ■ Product Advantages



high sensitivity



long term stability and reliability

#### Product Specifications

Model Number	Photovoltaic Infrared Detector		Photoconductive Infrared Detector
Active element material	InAsSb		HgCdTe
Active area	1mm*1mm		0.25mm*0.25mm
Spectral range	2μm ~ 5μm	-	2µm ~ 5µm
Cut-off wavelength	5μm (10%)	-	5μm (50%)
Peak wavelength	4.15μm	3.3/3.9/4.26µm(any available)	-
Peak current responsivity	> 1 A/W	> 0.5 A/W	> 1E4 V/W
Peak detectivity	> 2E9 cm · Hz <sup>1/2</sup> /W	> 1E9 cm · Hz <sup>1/2</sup> /W	> 1E10 cm · Hz <sup>1/2</sup> /W
Working condition	bias voltage:0V	bias voltage: 0V	bias current: 1mA
Package	TO39	TO46	TO66
Window	Si(AR)	Si(AR)	Sapphire (AR)
Feild of view	60°	90°	130°
Cooling	one-stage TE cooling	-	three-stage TE cooling
Working temperature	253K	room temperature	213~220K

## **MCT Cooled Infrared Detector**









VM0615M

#### ■ Product Advantages



MCT focal plane array



High performance and high reliability



The operating temperature of the chip is 80-100K



Universal interface



Mass production for better consistency

#### ■ Product Specifications

Model Number	VM0615M				
Array		640	×512		
Pixel Pitch		15	μm		
Detector spectral response		3.7µm	~4.8µm		
Array Operability		≥99	9.5%		
FPA Operating Temperature	81	0K	80K	100K	
Non-uniformity	≤,	7%	≤7%	≤7%	
Cryocooler	4	5.5	4	4	
F#(Upon Request)	≤17mk	≤20mk	≤17mk	≤20mk	
NETD	RM05	RM04	LS07	LS05E	
Cooldown Time	≤7min@23°C ≤5min@23°C		≤5min@23°C	≤5min@23°C	
Steady Input Power	≤8W@23°C ≤6W@23°C		≤8W@23°C	≤6W@23°C	
Weight	≤570g ≤380g		≤460g	≤260g	
Size(mm)	145×58.5×71	120.2×46.5×66.5	Compressor: Ф33.5×74.9 Dewar: 31.9×110	Compressor: Φ30×58 Dewar: Φ30×71.4	

## **MCT Cooled Infrared Detector**





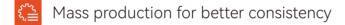
VM1215M VM1210M

#### ■ Product Advantages









#### ■ Product Specifications

Model Number	VM1215M	VM1210M
Array	1280x1024	1280x1024
Pixel Pitch	15μm	10μm
Detector spectral response	3.7μm~4.8μm	3.7μm~4.8μm
Array Operability	≥99.5%	≥99.5%
FPA Operating Temperature	80K	80K
Non-uniformity	≤8%	≤8%
Cryocooler	RM10	RM05
F#(Upon Request)	4	4
NETD	≤19mK	≤25mK
Cooldown Time	≤7min@23°C	≤7.5min@23°C
Steady Input Power	≤9W@23°C	≤9W@23°C
Weight	≤700g	≤570g
Size(mm)	151x77.5x56.5	145x58.5x71

## **InSb Cooled Infrared Detector**



#### ■ Product Advantages

inSb focal plane array

Universal interface

Voc gas detection application

High performance and high reliability

Mass production for better consistency

#### ■ Product Specifications

Model Number	VM0330A	VM0	615A	
Array	320×256	640×	512	
Pixel Pitch	30µm	15µm	1	
Detector spectral response	3.2µm~3.5µm	3.7µr	n∼4.8µm	
Array Operability	≥99.5%	≥99.5	5%	
FPA Operating Temperature	80K	80K		
Non-uniformity	≤7%	≤7%		
Cryocooler	RM05	RM05	RM04	
F#(Upon Request)	1.5	4	5.5	
NETD	≤17mk	≤17mk	≤20mk	
Cooldown Time	≤7min@23°C	≤7min@23°C	≤5min@23°C	
Steady Input Power	≤8W@23°C	≤8W@23°C	≤6W@23°C	
Weight	≤570g	≤570g	≤380g	
Size(mm)	142x58.5x71	145x58.5x71	120.2x46.5x66.5	

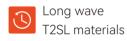
### **T2SL Cooled Infrared Detector**



Cooled Long Wave Infrared Detector-VL0615S

Cooled High-temperature Red Medium Wave Infrared Detector-VM0615R

#### ■ Product Advantages



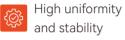


Universal interface



Mass production for better consistency

#### ■ Product Advantages





Long lifespan and low power consumption



temperature 120K



Small size and light weight

#### **■ Product Specifications**

Model Number	VL0615S	V	′M0615R	
Array	640×512	6-	40×512	
Pixel Pitch	15µm	15	5µт	
Detector spectral response	7.7μm ~ 9.5μm 7.7μm ~ 10.5μm	3.	.7μm~4.8μm	
Array Operability	≥99%	≥(	99.5%	
FPA Operating Temperature	80K	12	20K	
Non-uniformity	≤7%	<u>≤</u>	7%	
F#(Upon Request)	2	4		
NETD	≤35mK	_	40x512 mode: ≤20mK 20x256 binning mode: :	≤12mK
Cryocooler	RM05	RM04	RM02T	LS05E/LS05F
Cooldown Time	≤7min@23°C	≤4min@23°C	≤4min@23°C	≤4min@23°C
Steady Input Power	≤8W@23°C	≤4.5W@23°C	≤5W@23°C	≤4.5W@23°C
Weight	≤570g	≤380g	≤220g	≤280g
Size(mm)	145x58.5x71	120.2x46.5x66.5	91.4×42×42	Compressor: Φ30×58 Dewar: Φ30×71.2

### **InAsSb Cooled Infrared Detector**









Cooled High-temperature Blue Medium Wave Infrared Detector - VM0615B

High Operating Temperature Gas Detector - VM0615B

#### ■ Product Advantages





High MTTF and low input power

Small size and light weight

FPA Operating temperature at 150K

#### ■ Product Specifications

Model Number	Infrared Det	Infrared Detector-VM0615B			or-VM0615B	1
Array	640x512	640x512		640x512		
Pixel Pitch	15µm			15µm		
Detector spectral response	3.6μm~4.2μm			3.2µm~3.5µm		
Array Operability	≥99.5%			≥99.5%		
FPA Operating Temperature	150K			150K		
Non-uniformity	≤7%			≤10%		
F#(Upon Request)	4	4		1.2		
NETD		640x512 mode: ≤30mK 320x256 binning mode: ≤15mK		640×512模式: ≤15mK 320×256binning模式: ≤10mK		
Cryocooler	RM04	RM02T	LS05F	RM04	RM02T	LS05F
Cooldown Time	≤3min@23°C	≤3.5min@23°C	≤3min@23°C	≤3min@23°C	≤3.5min@23°C	≤3min@23°C
Steady Input Power	≤4W@23°C	≤3.5W@23°C	≤3W@23°C	≤4W@23°C	≤3.5W@23°C	≤3W@23°C
Weight	≤380g	≤220g	≤280g	≤380g	≤220g	≤280g
Size(mm)	120.2x46.5x66.5	91.4×42×42	Compressor: Φ28.5×58 Dewar: Φ34.2×69.3	120.2x46.5x66.5	91.3x42x42	Compressor: Φ28.5×58 Dewar: Φ34.2×69.3

## **Cooled Infrared Camera Core**

Cooled Infrared Camera Core is a high-performance thermal imaging component independently developed by VOT (Vital Optics Technology Co., Ltd). It has the advantages of small size, light weight and low input power, and can be used in security monitoring, forest fire prevention, gas detection, industrial inspection and other fields.

The product integrates a variety of image processing algorithms, suitable for different weather and scenes, providing rich details and superior image effects, and can provide data interface and SDK development kit to facilitate users' secondary development.

#### **SWIR** camera core



Te615D

#### **Product Advantages**

 It has the characteristics of high sensitivity, small size, light weight, low power consumption, and rich interfaces. Widely used in fields such as moisture detection, product detection and classification, foreign object detection, astronomical imaging, biomedicine, industrial monitoring, machine vision, etc.

	Performance		
Array	640×512		
Pixel Pitch	15µm		
Detector	InGaAs		
Frame Rate	25/50/100Hz		
Spectral Band	0.9~1.7μm		
Array Operability	≥99.8%		
Dark current	≤10nA/cm² @20°C		
Exposure Mode	Auto/Manual		
Digital video	Raw14bit		
Refrigeration mode	Secondary TEC refrigeration		
	Image processing		
lara and an analysis at	AULO:		
Image processing	NUC, image enhancement, digital denoising, automatic exposure, mixed dimming		
image processing	NUC, image enhancement, digital denoising, automatic exposure, mixed dimming  Electrical characteristic		
Supply voltage			
	Electrical characteristic		
Supply voltage	Electrical characteristic 9-26VDC		
Supply voltage Input power	Electrical characteristic 9-26VDC ≤5w@25°C(Excluding TEC)		
Supply voltage Input power Digital video	Electrical characteristic 9-26VDC ≤5w@25°C(Excluding TEC)  Cameralink/Ethernet		
Supply voltage Input power Digital video Communication interface	Electrical characteristic  9-26VDC  ≤5w@25°C(Excluding TEC)  Cameralink/Ethernet  RS422		
Supply voltage Input power Digital video Communication interface	Electrical characteristic  9-26VDC  ≤5w@25°C(Excluding TEC)  Cameralink/Ethernet  RS422  C-Mount		
Supply voltage Input power Digital video Communication interface Optical interface	Electrical characteristic  9-26VDC  ≤5w@25°C(Excluding TEC)  Cameralink/Ethernet  RS422  C-Mount  Physical property		
Supply voltage Input power Digital video Communication interface Optical interface Weight	Electrical characteristic  9-26VDC  ≤5w@25°C(Excluding TEC)  Cameralink/Ethernet  RS422  C-Mount  Physical property  ≤180g (Excluding lens)		
Supply voltage Input power Digital video Communication interface Optical interface Weight	Electrical characteristic  9-26VDC  ≤5w@25°C(Excluding TEC)  Cameralink/Ethernet  RS422  C-Mount  Physical property  ≤180g (Excluding lens)  ≤65.1×50×50mm		

## **Medium Wave Cooled Infrared Camera Core**



Operating temperature

Power Consumption

Size

Weight



Te0615A Te0615B

#### **Product Advantages**

- Equipped with high-performance signal processing circuits.
- CameraLink or Gigabit 14 bit RAW data output.
- Provide SDK development package, which is simple to develop and easy to integrate.
- Integrated structural design, with external dimensions consistent with the detector.
- Autonomous and controllable supply chain with guaranteed delivery.

-40°C~60°C

≤480g

115mm×55mm×72mm

Max≤19W@23°C;

Regular≤10W@23°C

Performance					
Array	640×512				
Pixel Pitch	15μm				
FPA spectral band	3.7μm~4.8μm				
F#	4	4			
Cryocooler	RM05	RM04			
Cooldown time	≤7min@23°C	≤6min@23°C			
Typical NETD	≤20mk	≤25mK			
	Image Processing				
Max. full frame rate	10	0Hz			
Dimming	Linear/h	istogram			
lmage algorithm	N	UC			
	Electrical Characteristic				
Standard external interface	Gigabit network/ CameraLink/PAL	Gigabit network/CameraLink/PAL			
Digital video	14bit RAW	14bit RAW			
Communication interface	RS422	RS422			
Supply voltage	DC-24V	DC-12V			

-40°C~60°C

Max≤19W@23°C;

Regular≤12W@23°C

≤1.1Kg

172.5mm×94mm×94.3mm

### **HOT Miniaturized Cooled Camera Core**





Te0615C

Te0615E

#### **Product Advantages**

- Product integration, adaptable to multiple lenses
- Localization of components, providing localized solutions
- Suitable for multiple scenarios, security monitoring, forest fire prevention, infrared non-destructive testing, etc
- Adopting self-developed image processing algorithms to highlight image details more prominently
- The device is designed to be miniaturized, with light weight and low power consumption

	Performance				
Array 640x512					
Pixel Pitch	15µm				
FPA spectral band	3.7µm ·	~4.8µm			
F#		4			
Cryocooler	RM02T	LS05E			
Cooldown time	≤4min@23°C	≤4min@23°C			
Typical NETD	640×512 mode: ≤25mK	640×512 mode: ≤25mK			
	Image Processing				
Max. full frame rate	25Hz	50Hz			
Dimming	Linear/histogram	Linear/histogram			
Image algorithm	NUC NUC				
	Electrical Characteristic				
Standard external interface	Gigabit network/CameraLink	CameraLink/PAL			
Digital video	14bit RAW	14/8bit RAW			
Communication interface	RS422	RS422			
Supply voltage	DC-12V	DC-12V			
Operating temperature	-40°C~60°C -40°C~60°C				
Size	97mmx50mmx42mm 78.5mm×89mm×51mm				
Weight	≤360g	≤380g			
Power Consumption	Max≤19W@23°C; Regular≤8W@23°C	Max≤34W@23°C; Regular≤10W@23°C			

### High-Temperature Medium Wave Gas Detection Camera Core





Te0615B-G

Te0615F-G

#### **Product Advantages**

- Equipped with high-performance signal processing circuits
- Multiple data output methods are available for selection:Gigabit network/CameraLink/PAL
- Provide SDK development package, which is simple to develop and easy to integrate
- Professional gas enhancement image algorithm to identify weak gas leaks
- Autonomous and controllable supply chain with guaranteed delivery

	Perfori	mance		
Array	640×512			
Pixel Pitch	15µm			
FPA spectral band	3.2µm ·	~ 3.5µm		
F#	1	.2		
Cryocooler	RM04	LS05F		
Cooldown time	≤3min@23°C	≤4min@23°C		
Typical NETD	640×512 mode: ≤20mK 640×512 mode: ≤20ml 320×256binning mode: ≤15mK 320×256binning mode: ≤1			
Gas detection type	methane, ethane, propane, butane, pentane, hexane, heptane, octane, ethylene, propylene, isoprene, methanol, ethanol, butanone, benzene, toluene, xylene, ethylbenzene, etc			
	Image Processing			
Max. full frame rate	640×512 mode: 90Hz 320×256binning mode: 200Hz	640×512 mode: 100Hz 320×256binning mode: 200Hz		
Dimming	Linear/histogram	Linear/histogram		
Image algorithm	NUC			
	Electrical Ch	aracteristic		
Standard external interface	Gigabit network/CameraLink/PAL	PAL/Cameralink/DVP		
Digital video	14bit RAW	14/8bit RAW		
Communication interface	RS422	RS422		
Supply voltage	DC-12V	DC-12V		
Operating temperature	-40°C~60°C	-40°C~60°C		
Size	115mm×55mm×72mm	93.8mm×75.4mm×60.9mm		
Weight	≤480g	≤440g		
Input power	Max≤19W@23°C; Regular≤9W@23°C	Max≤25W@23°C; Regular≤7W@23°C		

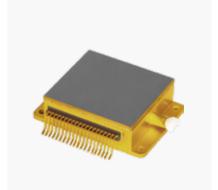
## **Uncooled Infrared Detector**

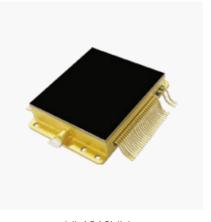
VOT has established an 8-inch silicon-based MEMS infrared detector production line, breaking through the chip technology of infrared thermal imaging, and mastering MEMS chip design technology, manufacturing process technology, and metal, ceramic and wafer-level encapsulation technology.

The uncooled infrared detectors feature small size, light weight, low cost, fast response speed, and wide spectral range. They are widely used in fields such as thermal imaging, fire alarms, industrial inspection, and security monitoring.

## **Metal Packaging Infrared Detector**







VL0617VM

VL0612VM

VL1212VM

#### ■ Product Advantages



High sensitivity and good reliability



Suitable for complex environmental scenarios

#### **■ Product Specifications**

Detector	VL0617VM	VL0612VM	VL1212VM
Array	640×512	640×512	1280×1024
FPA Spectral Band	LWIR,8µm~14µm	LWIR,8µm~14µm	LWIR,8µm~14µm
NETD	≤30 mk (@f/1.0,50Hz,300K)	≤40 mk (@f/1.0,50Hz,300K)	≤40 mk (@f/1.0,25Hz,300K)
Frame Rate	50Hz	50Hz	25Hz
Package Dimensions	23.5×32×7.7mm³ (Excluding Pin Dimensions)	23.5×32×7.7mm³ (Excluding Pin Dimensions)	40.5x30x8mm³ (Excluding Pin Dimensions)
Output Signal	Analog Output	Digital Output	Digital Output
Read out	Row-by-Row Readout	Row-by-Row Readout	Row-by-Row Readout
Pixel Pitch	17um	12um	12um
Power Consumption	≤350mW(@50Hz,300K, Excluding TEC)	≤180mW (@50Hz,300K, Excluding TECC)	≤500mW (@25Hz,300K, Excluding TEC)
Packaging Form	32pin Metal Vacuum Packaging	40pin Metal Vacuum Packaging	60pin Metal Vacuum Packaging
Weight	≤20g	≤25g	≤45g

## **Ceramic Packaging Detector**



#### ■ Product Advantages

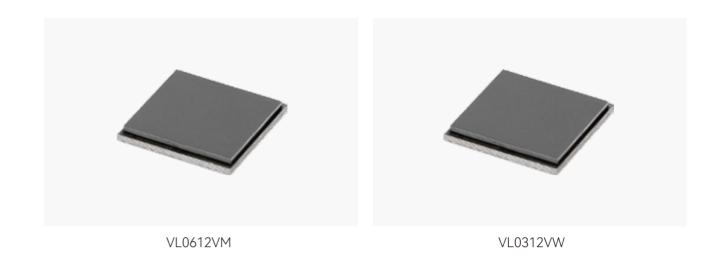


Compact size, high reliability, and low power consumption

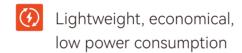
#### ■ Product Specifications

Detector	VL1212VC	VL0612VC	VL0312VC
Array	1280×1024	640×512	384×288
FPA Spectral Band	LWIR,8µm~14µm	LWIR,8µm~14µm	LWIR,8µm~14µm
NETD	≤40 mk (@25Hz,300K)	≤40mk (@f/1.0,50Hz,300K)	≤40 mk (@f/1.0,50Hz,300K)
Frame Rate	25Hz	50Hz	50Hz
Package Dimensions	28.5x28.5x4.1mm³ (Excluding Pin Dimensions)	22×22×4.68mm³ (Excluding Pin Dimensions)	22×22×4.68mm³ (Excluding Pin Dimensions)
Output Signal	Digital Output	Digital Output	Digital Output
Read out	Row-by-Row Readout	Row-by-Row Readout	Row-by-Row Readout
Pixel Pitch	12µm	12µm	12µm
Power Consumption	≤500mW (@25Hz,300K)	≤180mW (@50Hz,300K)	≤180mW (@50Hz,300K)
Packaging Form	60pin Ceramic Vacuum Packaging	32pin Ceramic Vacuum Packaging	32pin Ceramic Vacuum Packaging
Weight	≤11.2g	≤5.5g	≤5.5g

## **Wafer Packaging Detector**



#### ■ Product Advantages



Suitable for mini-module applications

#### ■ Product Specifications

Detector	VL0612VM	VL0312VW
Array	640×512	384×288
FPA Spectral Band	LWIR,8µm~14µm	LWIR,8µm~14µm
NETD	≤40 mk (@f/1.0,50Hz,300K)	≤40 mk (@f/1.0,50Hz,300K)
Frame Rate	50Hz	50Hz
Package Dimensions	12.95×12.52×1.45mm³	10.18×9.61×1.45mm³
Output Signal	Digital Output	Digital Output
Read out	Row-by-Row Readout	Row-by-Row Readout
Pixel Pitch	12µm	12μm
Power Consumption	≤180mW (@50Hz,300K)	≤180mW (@50Hz,300K)
Packaging Form	44pin Wafer Vacuum Packaging	44pin Wafer Vacuum Packaging
Weight	≤0.5g	≤0.3g

## Uncooled Infrared camera core

The uncooled camera core is equipped with 384x288 or 640x512 infrared detector, high-performance signal processing circuits, and proprietary image processing algorithms of VOT, offering high image quality with sharp edges, a sense of depth, fast frame rates, and high temperature measurement accuracy.

The uncooled camera core has the advantages of small size, low power consumption, high cost-performance ratio, and customization capabilities. It is suitable for the development and integration of infrared thermal imaging equipment or systems in various fields, as well as the integration of various imaging systems and optoelectronic systems. It can be applied in the field of industrial process or quality control systems, security monitoring, vehicle night vision, the Internet of Things, drones, and Industry 4.0 etc.

#### **UCC3 Series Camera Core**

#### UCC3843/UCC6403

The UCC3 series camera core is equipped with 384×288/640×512 infrared detector, high-performance signal processing circuits, and proprietary image processing algorithms of VOT, offering high image quality with sharp edges, a sense of depth, fast frame rates, and high temperature measurement accuracy.



#### ■ Product Advantages

- Domestic production.
- High sensitivity for clear and stable imaging quality.
- Compact size, lightweight, and low power consumption.
- Highly integrated for easy secondary develop-
- Wide temperature range with high precision, easily adapting to various scenes.
- High frame rate for smooth detection of fastmoving targets.

■ Product S <sub>l</sub>	pecifica	tions								
Detector Pe	erformar	nce				Image Fun	ctio	n		
Detector Type	VOx					Brightness Contra	ast	Auto/Man	ual	
Resolution	640x5	512		384×28	384×288 Polarity			Whitehot, Blackhot		
Pixel Pitch	12µm	12μm			Color Palette		Iron Red、Anti-Iron Red、Rainbow、Feather Rainb			
NETD	≤40m	K				Digital Zoom	Digital Zoom X1, X2, X4		4	
Frame Frequency	≤60Hz			Image Processing	9		ormity Correction, Digital Filtering for uction, Digital Detail Enhancement			
Spectral Band	8~14µ	ım				Image Mirroring		Horizonta	al (Left/Right) or Vertical (Up/Down)	
Lens Option	าร					Environme	ntal	Param	neters	
Lens		tandard)				Operation Temper	rature	-20°C~60°	°C	
	6/9/13/19	9/35/50/75m	ım (sele	ctable)		Storage Temperature −45°C~85°C		C		
	6mm	65.2°x54.	2°	2° 42.0°x32.1°		Humidness	-lumidness 5~95%, N		on-condensing	
	9mm	46.2°x37.	7°	28.7°x2	1.7°			6.06g, Random Vibration, All Axial Directions		
	13mm	32.9°x26.	6°	20.1°x15	5.1°			80g,4ms,Back Peak Sawtooth,3 Axes,6 Direction		
Field of View	19mm	22.9°x18.	4°	13.8°x10	Power Supply		ply	y		
	25mm	17.5°x14.0	)°	10.5°x7.	99°	9° Power Supply Ove		Overvoltage Protection, Reverse Input Protection, High Voltage Surge Suppression		
	35mm	12.5°x10.0	0°	7.5°x5.7	0					
	50mm	8.8°x7.0°		5.3°x4.0	)°	Power Input	DC	5~12V		
	75mm	5.9°x4.7°		3.5°x2.6	°	Power Wastage	≤ 1\	N		
Interface			Tem	perature	Measuri	ng Function	Ph	ysical	Parameter	
Video Output	CVBS, USB (UVC) BT.656		Measurement		-20°C~15 140°C~60		Dim	ensions	26×26×21.1mm (excluding lens and connector)	
Communication Method	RS-232		Temperature Measurement Accuracy		±2°C or 2% of the reading		Wei	ght	≤23g (excluding lens and connector)	

## **Fireye Series Camera Core**

The camera core, with its outstanding performance, stable structure, and flexible configurability, is suitable for the development and integration of infrared thermal imaging equipment or systems in various fields, as well as the integration of various imaging complete machines and optoelectronic systems. It can be applied to vehicle night vision, security monitoring, outdoor sports, fire rescue, law enforcement search, rescue and other fields.



shutter



shutterless

#### ■ Product Advantages

- High sensitivity for clear and stable imaging quality.
- High-performance design with a stable structure, adaptable to various harsh environments.
- A variety of lens specifications and customizable interface modules to meet personalized needs.
- Highly integrated for easy secondary development
- High frame rate ensures smooth observation of high-speed moving targets without lag.

#### **■ Product Specifications**

Detector Performance			
Detector Type	Uncooled VOx Mi	crobolometer	
Resolution	384x288	640x512	
PixelsSize	12µm		
NETD	≤50mK, @F1.0, 3	00K	
Frame Frequency	50Hz		
Spectral Band	8~14μm		

Lens Options (Selectable)				
Lens		9.1/13/19/25/35/50mm, F1.0		
Focusing Method		Manual		
	9.1mm	28.9°×21.62°	49.1°×38.74°	
	13mm	20.1°×15.14°	32.91°×26.59°	
Field of View	19mm	13.83°×10.39°	22.85°×18.37°	
	25mm	10.53°×7.91°	17.46°×14.01°	
	35mm	7.53°×5.65°	12.52°×10.03°	
	50mm	5.28°×3.96°	8.78°×7.03°	

Interface	
Analog Video	CVBS
Digital Video	BT.656/LVDS/MIPI/Cameralink/SDI/ETH (Selectable)
Communication Interrace	UART/RS232

Image Funct	on			
Image Correction	Shutter/Shutterless (Selectable)			
Brightness Contras Adjustment	Auto/Manual			
Digital Zoom	1-8x			
Reticle	Show/Hide/Move			
Color Palette	Whitehot/Blackhot/Iron/Rainbow			
Image Processing	Non-uniformity Correction, Digital Filtering for Noise Reduction, Digital Detail Enhancement.	,		
Environment	al Parameters			
Vibrator	6.06g,Random Vibration, All Axial Di	6.06g,Random Vibration, All Axial Directions		
Reliability	200g, 4ms, Back Peak Sawtooth, 3 / 6 Directions	200g, 4ms, Back Peak Sawtooth, 3 Axes, 6 Directions		
Humidness	5~95%, Non-condensing	5~95%, Non-condensing		
Operation Tempera	ure -20°C~+55°C			
Storage Temperatu Range	-55°C~+70°C	-55°C~+70°C		
Power Suppl				
Power Supply Prot	ction Supporrs Over-voltage, Under-vo			
Power Input	DC 3.8~5.5V			
Power Wastage	≤1W	≤1W		
Physical Para	meter			
Weight	hutter≤22.3g/shutterless≤20g (excluding	g lens)		
Dimensions	25mm×25mm×18.5mm (excluding lens)			

